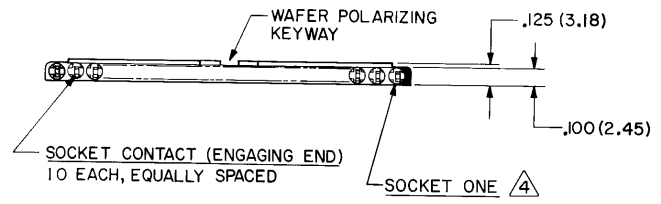
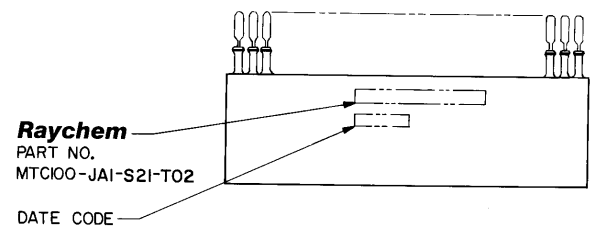
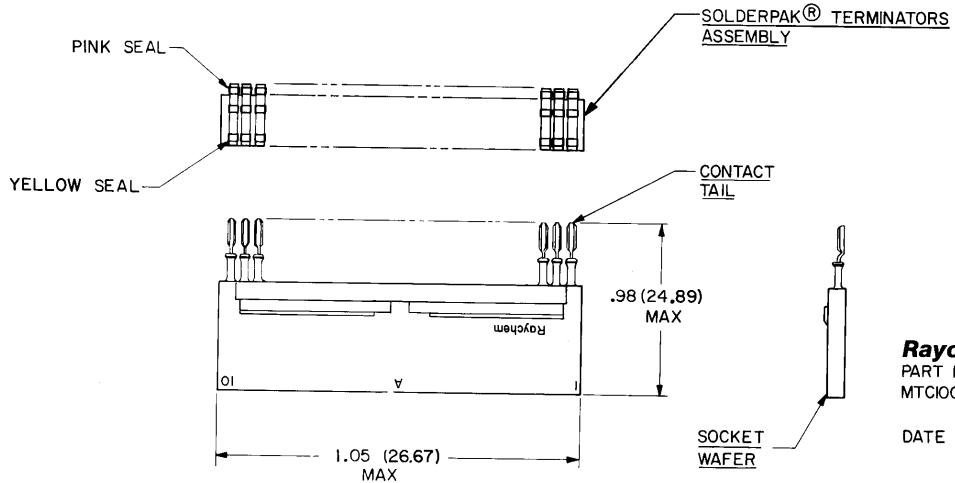


REV	DATE	BY	APP
A	CHG'D PER DCO # T-02584	W.J.	



5 WEIGHT (MAX.): $\frac{\text{LBS.}}{.0054} \mid \frac{\text{GRAMS}}{2.46}$

4 SOCKET ONE: SOCKET NUMBER ONE MARKED IN CONTRASTING COLOR.

3. WAFER : WAFER MEETS THE REQUIREMENTS OF RAYCHEM SPECIFICATION D-6011.
2. FINISH :
- 2-A SOCKET WAFER ; FINISH TO BE AS MOLDED.
 - 2-B SOCKET CONTACT (ENGAGING END) ; GOLD PLATE PER MIL-G-45204 CLASS I.
 - 2-C CONTACT TAIL ; COATED WITH SOLDER PER QQ-S-571.
1. MATERIAL :
- 1-A SOCKET WAFER ; HIGH GRADE POLYARYLENE THERMO-PLASTIC.
 - 1-B SOCKET CONTACT ; COPPER ALLOY PER QQ-B-750 (A).
 - 1-C SOLDERPAK® TERMINATORS ASSY ; REFER TO RAYCHEM DWG. CTA-0026 FOR DATA.

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SPECIFICATION CONTROL DRAWING

UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN INCHES BRACKETED DIMENSIONS () ARE METRIC AND TOLERANCES ARE: .XXX: ± .005 (0.13 M.M.) .XX: ± .02 (0.51 M.M.) Δ: ± —	DRAWN	W.V.J.	1-15-81	Raychem <small>RAYCHEM CORPORATION 300 CONSTITUTION DRIVE MENLO PARK, CALIFORNIA 94025</small> TITLE KIT, 1" SOCKET WAFER "A" WITH SOLDERPAK® TERMINATORS, FOR ROUND WIRE (20-26 AWG), 150°C TEMPERATURE RATING MTC 100 SERIES						
	CHECKED	<i>[Signature]</i>								
	APPROVED	<i>[Signature]</i>	1-22-81							
	APPROVED	<i>[Signature]</i>	2-6-81							
				<table border="1"> <tr> <td>SIZE</td> <td>CODE IDENT</td> <td>DWG. NO.</td> </tr> <tr> <td>C</td> <td>NO. 06090</td> <td>MTC100-JAI-S21-T02</td> </tr> </table>	SIZE	CODE IDENT	DWG. NO.	C	NO. 06090	MTC100-JAI-S21-T02
SIZE	CODE IDENT	DWG. NO.								
C	NO. 06090	MTC100-JAI-S21-T02								
				<table border="1"> <tr> <td>WEIGHT</td> <td>Δ</td> <td>SHEET 1 OF 1</td> </tr> </table>	WEIGHT	Δ	SHEET 1 OF 1			
WEIGHT	Δ	SHEET 1 OF 1								

DO NOT SCALE THIS DRAWING

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NOTES